Erratum

Erratum to “Preparation of $\text{Cu}_2\text{Sn}_3\text{S}_7$ Thin-Film Using a Three-Step Bake-Sulfurization-Sintering Process and Film Characterization”

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In the article titled “Preparation of $\text{Cu}_2\text{Sn}_3\text{S}_7$ Thin-Film Using a Three-Step Bake-Sulfurization-Sintering Process and Film Characterization” [1], the name of the first author was given incorrectly as Tai-Hsiang Lui. The author’s name should have been written as Tai-Hsiang Liu. The revised authors’ list is shown above.

References

- [1] T.-H. Lui, F.-Y. Hung, T.-S. Lui, and K.-J. Chen, “Preparation of $\text{Cu}_2\text{Sn}_3\text{S}_7$ thin-film using a three-step bake-sulfurization-sintering process and film characterization,” *Journal of Nanomaterials*, vol. 2015, Article ID 969783, 7 pages, 2015.